

C1808C392GCGAC7210

SMD Comm COG HV, Ceramic, 3900 pF, 2%, 500 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1808



Click here for the 3D model.

Dimensions		
Chip Size	1808	
L	4.7mm +/-0.5mm	
W	2mm +/-0.2mm	
T	1.4mm +/-0.15mm	
В	0.6mm +/-0.35mm	

Packaging Specifications		
Packaging	T&R, 330mm, Plastic Tape	
Packaging Quantity	4000	

General Information	
Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	62 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	3900 pF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	2%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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